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- 5-Ω Switch Connection Between Two Ports
- TTL-Compatible Input Levels
- Designed to Be Used in Level-Shifting Applications
- Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages

description

The SN74CBTD16210 provides 20 bits of high-speed TTL-compatible bus switching. The low on-state resistance of the switch allows connections to be made with minimal propagation delay. A diode to V_{CC} is integrated in the circuit to allow for level shifting between 5-V inputs and 3.3-V outputs.

The device is organized as a dual 10-bit bus switch with separate output-enable (\overline{OE}) inputs. It can be used as two 10-bit bus switches or as one 20-bit bus switch. When \overline{OE} is low, the associated 10-bit bus switch is on, and port A is connected to port B. When \overline{OE} is high, the switch is open, and a high-impedance state exists between the ports.

The SN74CBTD16210 is characterized for operation from -40°C to 85°C.

DGG, DGV, OR DL PACKAGE (TOP VIEW)

	•		
NC [1 U	48	10E
1A1 [2	47	20E
1A2 [3	46] 1B1
1A3 [4	45] 1B2
1A4 [5	44] 1B3
1A5 [6	43] 1B4
1A6 🛚	7] 1B5
GND [8		GND
1A7 🛚	9	40] 1B6
1A8 🛚	10	39] 1B7
1A9 🛚	11	38] 1B8
1A10	12	37	1B9
2A1	13	36	1B10
2A2	14	35	2B1
V _{CC}	15	34	2B2
2A3	16		2B3
GND [17		GND
2A4 🛚	18		2B4
2A5 🛚	19		2B5
2A6	20	29	2B6
2A7	21		2B7
2A8 🛚	22	27	2B8
2A9 🏻	23	26	2B9
2A10	24	25	2B10

NC - No internal connection

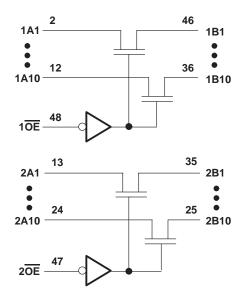
FUNCTION TABLE (each 10-bit bus switch)

(
INPUT FUNCTION				
L	A port = B port			
Н	Z			

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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		
Input voltage range, V _I (see Note 1)		
Continuous channel current		128 mA
Input clamp current, $I_{IK}(V_I < 0)$		
Package thermal impedance, θ _{JA} (see Note 2)	: DGG package	70°C/W
	DGV package	58°C/W
	DL package	63°C/W
Storage temperature range, T _{stg}		

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
VCC	Supply voltage	4.5	5.5	V
VIH	High-level control input voltage	2		V
V _{IL}	Low-level control input voltage		0.8	V
TA	Operating free-air temperature	-40	85	°C

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT				
VIK		$V_{CC} = 4.5 \text{ V},$	I _I = -18 mA				-1.2	V	
Vон		See Figure 2							
Н		$V_{CC} = 0 V$,	V _I = 5.5 V				10		
		$V_{CC} = 5.5 \text{ V},$	$V_I = 5.5 \text{ V or GND}$				±1	μΑ	
Icc		$V_{CC} = 5.5 \text{ V},$	I _O = 0,	$V_I = V_{CC}$ or GND			1.5	mA	
∆l _{CC} ‡	Control inputs	$V_{CC} = 5.5 \text{ V},$	One input at 3.4 V,	Other inputs at V _{CC} or GND			2.5	mA	
Ci	Control inputs	V _I = 3 V or 0				4.5		pF	
C _{io(OFF)}		$V_{O} = 3 \text{ V or } 0,$	OE = V _{CC}			5.5		pF	
r _{on} §		V _{CC} = 4.5 V	V _I = 0	I _I = 64 mA		5	7		
				I _I = 30 mA		5	7	Ω	
			V _I = 2.4 V,	I _I = 15 mA		35	50		

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	MAX	UNIT
$t_{pd}\P$	A or B	B or A		0.25	ns
t _{en}	ŌĒ	A or B	1.5	9.8	ns
^t dis	ŌĒ	A or B	1.5	8.9	ns

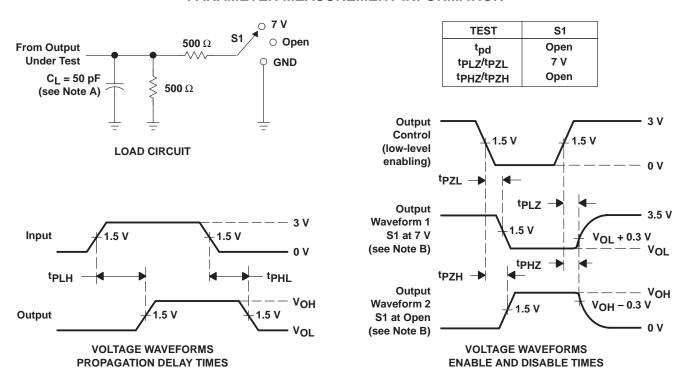
The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).



[‡] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

[§] Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

PARAMETER MEASUREMENT INFORMATION

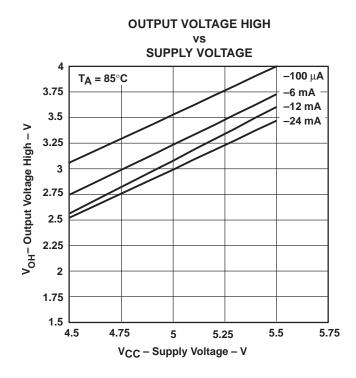


NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq$ 2.5 ns. $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

TYPICAL CHARACTERISTICS



OUTPUT VOLTAGE HIGH SUPPLY VOLTAGE $T_A = 25^{\circ}C$ **–100** μ**Α** 3.75 3.5 -6 mA V_{OH}- Output Voltage High - V –12 mA 3.25 –24 mA 3 2.75 2.5 2.25 2 1.75 1.5 4.5 4.75 5.5 5.75 5 5.25 V_{CC} - Supply Voltage - V

SUPPLY VOLTAGE $T_A = 0^{\circ}C$ 3.75 3.5 -6 mA 3.25 3 2.75 2.5

OUTPUT VOLTAGE HIGH

-100 μA V_{OH} – Output Voltage High – V -12 mA -24 mA 2.25 2 1.75 1.5 4.5 4.75 5.5 5.75 5 5.25 V_{CC} – Supply Voltage – V

Figure 2. V_{OH} Values

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